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LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Pierre JEANVOINE et al.

FILING DATE

MARCH 1, 2000

GROUP

1731

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Examiner

Jean Voine

Date Considered

8-12-02

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.